

Product Change Notification / ASER-19HIW0872

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28-Oct-2022

Product Category:

8-bit Microcontrollers

PCN Type:

Manufacturing Change

Notification Subject:

CCB 4748 Final Notice: Qualification of MTAI as an additional assembly site for selected ATMEGA324PBxxx and PIC16F1xxx device families available in 44L TQFP (10x10x1mm) package.

Affected CPNs:

ASER-19HIW0872_Affected_CPN_10282022.pdf ASER-19HIW0872_Affected_CPN_10282022.csv

Notification Text:

PCN Status: Final Notification

PCN Type:Manufacturing Change

Microchip Parts Affected:Please open one of the files found in the Affected CPNs section. Note: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

Description of Change:Qualification of MTAI as an additional assembly site for selected ATMEGA324PBxxx and PIC16F1xxx device families available in 44L TQFP (10x10x1mm) package.

Pre and Post Change Summary:

	Pre Change	Post Change
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Assembly Site		ASE Group Chung-Li (ASCL)	ASE Group Chung-Li (ASCL)	Microchip Technology Thailand (MTAI)					
Moisture Sensitivity Level (MSL)		MSL3	MSL3	MSL1					
Shipping	Tray	Blue Bakeable	Blue Bakeable	Dark Blue Non-bakeable					
Media	T/R	No Change	No Change	No Change					
Wire Material		Au/CuPdAu	Au/CuPdAu	Au					
Die At	tach Material	EN-4900GC	EN-4900GC	3280					
Molding Compound Material		G700	G700	G700					
	Material	EFECT64	EFECT64	C7025					
Lead	Paddle Size	Paddle Size 205 x 205 mils		180 x 180 mils					
Frame	DAP Surface Prep	Ag ring plate	Ag ring plate	Bare Copper					
	See Pre and Post Change Summary for Lead Frame comparison.								

Impacts to Data Sheet:None

Change ImpactNone

Reason for Change:To improve manufacturability by qualifying MTAI as an additional assembly site.

Change Implementation Status:In Progress

Estimated First Ship Date: November 10, 2022 (date code: 2246)

Note: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Time Table Summary:

	August 2021						October 2022				November 2022					
Workweek	3 2	3	3 4	3 6	3 6		4 0	4 1	4 2	4 3	4 4	4 5	4 6	4 7	4 8	4 9
Initial PCN Issue Date				Х												
Qual Report Availability											Х					
Final PCN Issue											Х					

Date									
Estimated Implementation Date							Х		

Method to Identify Change: Traceability code

Qualification Report:Please open the attachments included with this PCN labeled as PCN_#_Qual_Report.

Revision History: August 26, 2021: Issued initial notification.

March 29, 2022: Issued final notification. Provided estimated first ship date to be on April 29, 2022.

September 30, 2022: Re-issued final notification. Updated wire material for ASCL assembly site to add CuPdAu bond wire. Updated affected part list to remove catalog part numbers ATMEGA324PB-AN, ATMEGA324PB-ABT and add CPN PIC16F18075-I/P based on the updated scope. Updated subject notification, reason for change and qual title accordingly.

October 28, 2022: Re-issued final notification with qual report. Updated Estimated Implementation and Estimated First Ship date to November 10, 2022.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachments:

PCN_ASER-19HIW0872_Qual Report.pdf PCN_ASER-19HIW0872_Pre and Post Change_Summary.pdf

Please contact your local Microchip sales office with questions or concerns regarding this notification.

Terms and Conditions:

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If you wish to <u>change your PCN profile</u>, <u>including opt out</u>, please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make

the applicable selections.	

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Affected Catalog Part Numbers (CPN)

ATMEGA324PB-ANR

ATMEGA324PB-AUR

PIC16F15274-E/PT

PIC16F15275-E/PT

PIC16F15276-E/PT

PIC16F15274-I/PT020

PIC16F15274-I/PT

PIC16F15275-I/PT

PIC16F15276-I/PT

PIC16F18075-I/PT

ATMEGA324PB-AU

ATMEGA324PB-AN

ATMEGA324PB-ABTVAO

Date: Friday, October 28, 2022